

T-01-13

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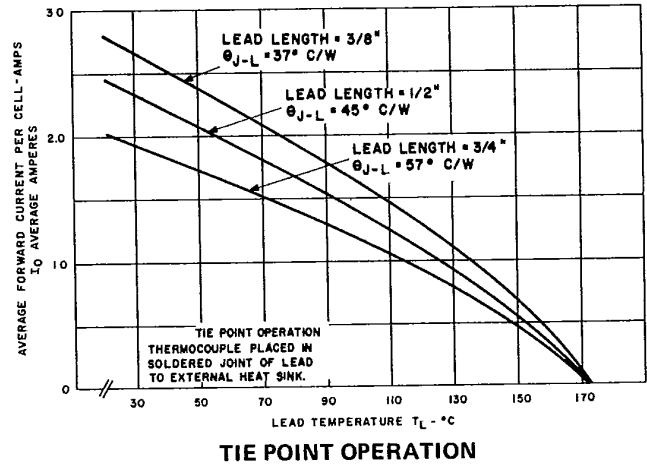
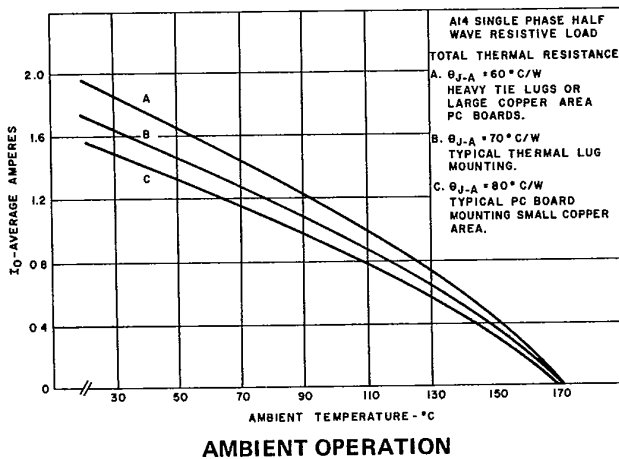
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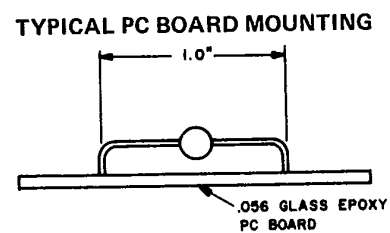
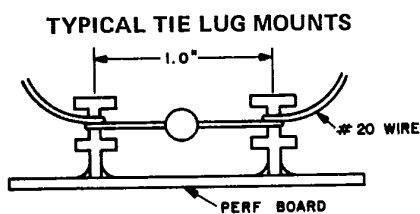
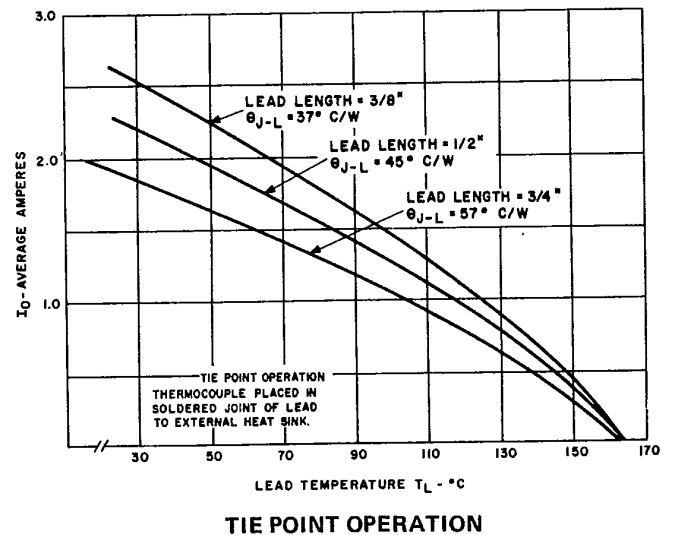
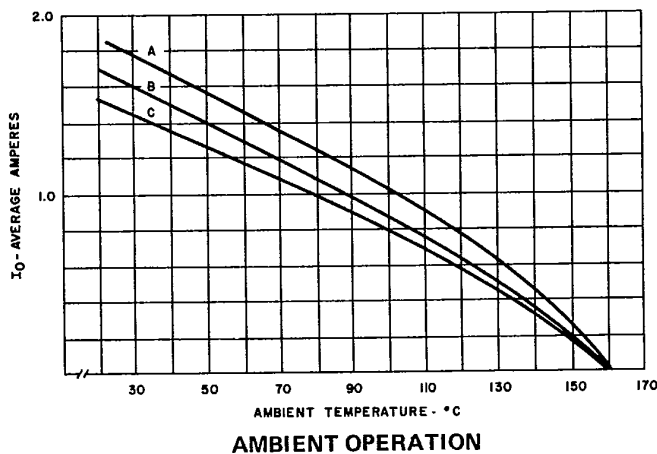
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MAXIMUM ALLOWABLE DC OUTPUT CURRENT RATINGS
SINGLE PHASE
600 VOLTS & BELOW



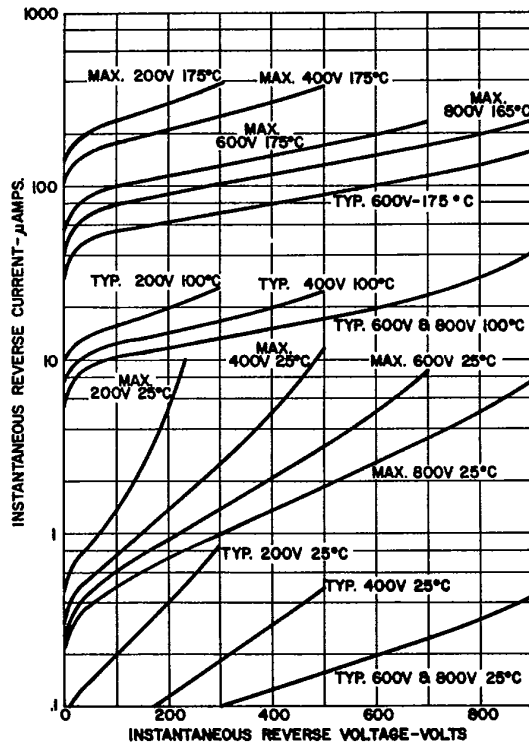
RESISTIVE OR INDUCTIVE LOAD
800 AND 1000 VOLTS



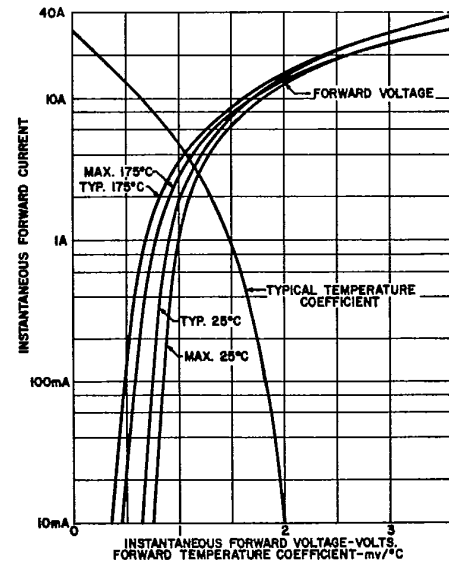
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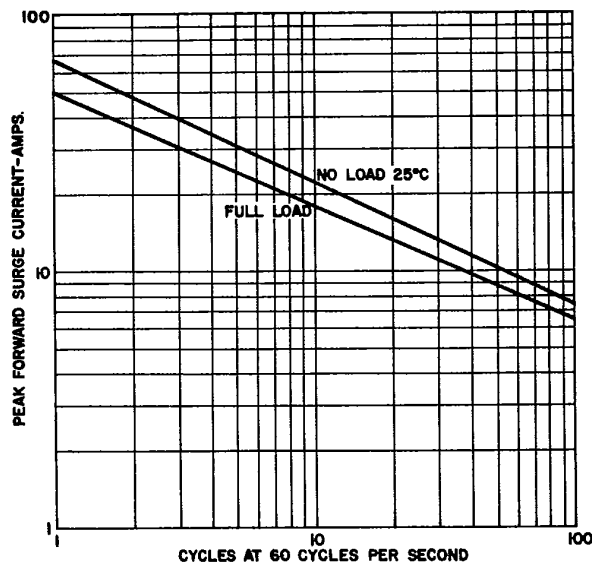
TYPICAL CHARACTERISTICS



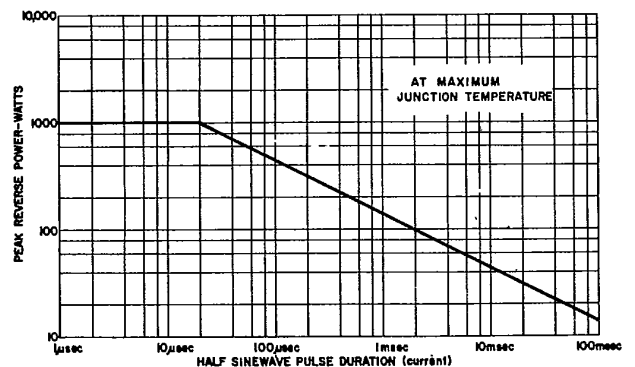
REVERSE CHARACTERISTICS AT SELECTED JUNCTION TEMPERATURES



FORWARD CHARACTERISTICS



MAXIMUM NON-REPETITIVE MULTICYCLE FORWARD SURGE CURRENT



MAXIMUM NON-REPETITIVE AVALANCHE SURGE POWER

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CAPACITIVE LOADS

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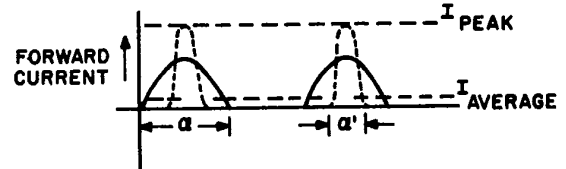
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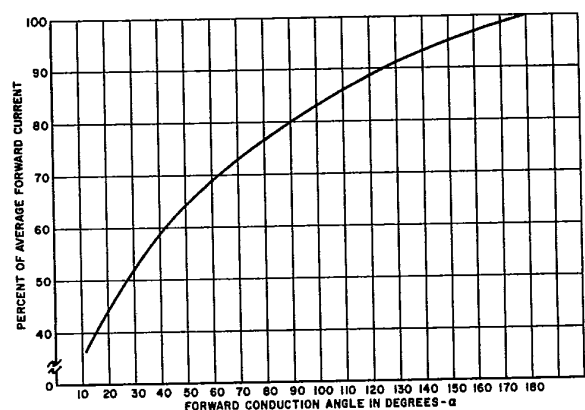
Current Derating (capacitive load)

Average forward current as specified under MAXIMUM RATINGS page 1 and derating curves for high temperature operation page 2, must be corrected for applications with capacitive loads. As the current conduction angle, α' , is decreased, the peak current required to maintain the same average current increases, i.e., the peak-to-average current ratio increases from 3.14. Figure 9 gives the derating required based on this increase in peak to average current ratio for sine wave operation. For more complete information consult Application Note 200.30.

- METHOD: 1. Determine conduction angle α' in degrees for particular circuit as designed.
2. Enter Figure 9 for the particular conduction angle and read corresponding percent of forward current per cell.
3. Multiply this value times average forward current for resistive load from figures on page 2 as given for the actual ambient or tiepoint temperature required.

 α = CONDUCTION ANGLE (180°) α' = SHORTENED CONDUCTION ANGLE

OSCILLOSCOPE PRESENTATION



9. DERATING FOR SHORTENED CONDUCTION ANGLE

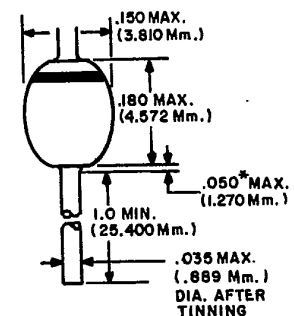
TYPICAL EXAMPLES (25°C Ambient Temperature)

	Example No. 1	Example No. 2	Example No. 3	Example No. 4	Units
Input Voltage	100	100	300	300	Volts
D.C. (Average) Output Voltage	34	75	180	270	Volts
Surge Resistor	1	1	3.5	3.5	Ohms
Load Current	0.5	0.5	0.5	0.5	Amps.
Input Filter Capacitance	30	100	30	100	μ F.
Conduction Angle	170	70	90	50	Degrees
Rated Average Current (Resistive Load)	1	1	1	1	Amp.
Rated Average Current (Capacitive Load)	0.98	0.73	0.80	0.65	Amp.

INTERNAL CONSTRUCTION

1. Dual heatsink design for maximum heat dissipation under both surge and continuous duty. No fragile "whiskers" or S leads with their potential trouble spots.
2. Glass Package. No internal cavity to act as potential source of moisture or contamination on junction. Temperature coefficient of the glass is matched with the internal parts.
3. Diffused silicon junction passivated surface.

Marking band to appear on cathode end.



OUTLINE DRAWING

ALL DIMENSIONS ARE IN INCHES AND (METRIC)

*WELD AND SOLDER FLASH NOT CONTROLLED IN THIS AREA

TYPICAL APPLICATIONS

- FREE-WHEELING RECTIFIERS
- TIME DELAY CIRCUITS
- POWER LOGIC CIRCUITS
- ARC SUPPRESSION
- BATTERY CHARGERS
- TV DAMPER DIODES

- TV AND RADIO POWER SUPPLIES
- COMMUNICATION EQUIPMENT
- S.C.R. TRIGGER CIRCUITS
- SMALL PORTABLE APPLIANCES
- GENERAL PURPOSE POWER SUPPLIES
- LOW LEVEL LIMITERS

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